1735446-6 - ACTIVE

TE Internal #: 1735446-6 PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, Natural, Bag

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 2.0 mm Headers



Connector System: Wire-to-Board

Number of Positions: 6

Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in]

PCB Mount Orientation: Vertical

All AMP HPI 2.0 mm Headers (205)

Features

Product Type Features

 Connector System
 Wire-to-Board

 Header Type
 Partially Shrouded

Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		
Connector Contact Load Condition	Fully Loaded	
Number of Positions	6	
Number of Rows	1	
PCB Mount Orientation	Vertical	
Electrical Characteristics		
Operating Voltage	250 VAC	
Body Features		
Primary Product Color	Natural	
Contact Features		
Contact Mating Area Length	3.35 mm[.131 in]	
Mating Square Post Dimension	.5 mm[.02 in]	

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, Natural, Bag



PCB Contact Termination Area Plating Material Thickness	2.03 μm[79.92 μin]	
Contact Layout	Inline	
PCB Contact Termination Area Plating Material Finish	Bright	
Contact Shape & Form	Square	
Contact Mating Area Plating Material Finish	Bright	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Copper Alloy	
Contact Mating Area Plating Material	Tin	
Contact Type	Pin	
Contact Current Rating (Max)	3 A	
Termination Features		
Square Termination Post & Tail Dimension	.5 mm[.02 in]	
Termination Post & Tail Length	3.4 mm[.134 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mechanical Attachment Mating Alignment Type	Polarization	
	Polarization With	
Mating Alignment Type		
Mating Alignment Type Mating Retention	With	
Mating Alignment Type Mating Retention PCB Mount Retention Type	With Retention Solder Tails	
Mating Alignment Type Mating Retention PCB Mount Retention Type Mating Retention Type	With Retention Solder Tails Locking	
Mating Alignment Type Mating Retention PCB Mount Retention Type Mating Retention Type Connector Mounting Type	WithRetention Solder TailsLockingBoard Mount	
Mating Alignment Type Mating Retention PCB Mount Retention Type Mating Retention Type Connector Mounting Type Mating Alignment	WithRetention Solder TailsLockingBoard MountWith	
Mating Alignment TypeMating RetentionPCB Mount Retention TypeMating Retention TypeConnector Mounting TypeMating AlignmentPCB Mount Alignment	WithRetention Solder TailsLockingBoard MountWith	
Mating Alignment TypeMating RetentionPCB Mount Retention TypeMating Retention TypeConnector Mounting TypeMating AlignmentPCB Mount AlignmentPCB Mount Retention	WithRetention Solder TailsLockingBoard MountWithWithout	
Mating Alignment Type Mating Retention PCB Mount Retention Type Mating Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention	WithRetention Solder TailsLockingBoard MountWithWithoutWithout	
Mating Alignment TypeMating RetentionPCB Mount Retention TypeMating Retention TypeConnector Mounting TypeMating AlignmentPCB Mount AlignmentPCB Mount RetentionHousing FeaturesHousing Material	WithRetention Solder TailsLockingBoard MountWithWithoutThermoplastic	
Mating Alignment TypeMating RetentionPCB Mount Retention TypeMating Retention TypeConnector Mounting TypeMating AlignmentPCB Mount AlignmentPCB Mount RetentionHousing FeaturesHousing MaterialCenterline (Pitch)	WithRetention Solder TailsLockingBoard MountWithWithoutThermoplastic	
Mating Alignment Type Mating Retention PCB Mount Retention Type Mating Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material Centerline (Pitch)	WithRetention Solder TailsLockingBoard MountWithWithoutWithout2 mm[.079 in]	
Mating Alignment TypeMating RetentionPCB Mount Retention TypeMating Retention TypeConnector Mounting TypeMating AlignmentPCB Mount AlignmentPCB Mount RetentionPCB Mount RetentionHousing FeaturesHousing MaterialCenterline (Pitch)DimensionsConnector Length	WithRetention Solder TailsLockingBoard MountWithWithoutWithoutThermoplastic2 mm[.079 in]14 mm[.551 in]	

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, Natural, Bag



Usage Conditions	
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	350
Packaging Method	Bag
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024

(240)

Does not contain REACH SVHC

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Halogen Content

Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, Natural, Bag





Customers Also Bought



CRGCQ 0402 820R 1%	IMP100S,H,V3P8C,UG,OEW46,4.9	MBXL VERT HDR 4ACP STR	OSFP-RHS 1X1, W/ EXTRUDED HS, SAN
TE Part #6565199-3 TC-ZIF HDR ASSY 260P SHIELD			
FINGER			
Documents			
Product Drawings			

2MM PITCH HPI POST HEADER, VERTICAL, 6P

English

CAD Files

Customer View Model

ENG_CVM_CVM_1735446-6_C.2d_dxf.zip

English

3D PDF

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, Natural, Bag



3D

Customer View Model ENG_CVM_CVM_1735446-6_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1735446-6_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages HPI Connectors QRG English

Product Specifications Application Specification

English